

IN THE CLAIMS

Please cancel claims 1-10, 24-26, and 28. Please add claim 33.

1-32. (Cancelled)

33. (New) An integrated circuit package comprising:

- a molded plastic body having a first side and a second side opposite the first side;

- at least four plastic posts arranged in a checkerboard pattern, each said post extending integrally from the second side of said body;

- a plurality of electrically separate metal terminals coating a sidewall of at least one of said posts;

- a plurality of electrically conductive circuit patterns on the first side of the plastic body;

- an integrated circuit including a plurality of bond pads, said integrated circuit mounted on the first side of said body and the bond pads electrically coupled to at least some of the circuit patterns;

- a plurality of electrically conductive vias extending through the plastic body from the first side to the second side, wherein at least some of the terminals on each of the at least four posts are electrically connected to the integrated circuit through a said circuit pattern and a said via; and

- an encapsulant covering the integrated circuit.